



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney Docket No.: 0408941-5653

PATENT

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TECHNOLOGY CENTER 2800

#4/A
3-16-2
Robert
and

In re Application of:

Satoshi NAKAMURA

Application No.: 09/818,686

Filed: March 28, 2001

For: PRINTED WIRING BOARD HAVING
HEAT RADIATING MEANS AND
METHOD OF MANUFACTURING THE
SAME

Group Art Unit: 2835

Examiner: Boris L. Chervinsky

Commissioner for Patents
Washington, DC 20231

Sir:

AMENDMENT

In response to the Office Action dated November 29, 2001 (Paper No. 4), the period for response to which extends through February 28, 2002, please amend the above-identified

application as follows:

03/05/2002 JBALINAN 00000059 09818686

01 FC:103 18.00 CH
02 FC:104 280.00 CH

IN THE ABSTRACT:

Kindly amend the abstract to read as follows.

At BI
In the present invention, a printed wiring board with an electronic component mounted on a circuit board in which the electronic component is provided with a heat radiating plate for conducting heat internally generated, is characterized in that the heat radiating means is mounted by its surface at a position corresponding to the electronic component on a rear surface of the circuit board.

03/05/2002 JBALINAN 00000059 500310 09818686

01 FC:103 18.00 CH

200.00 CH